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**Identification cards — Physical characteristics —
Amendment**

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**AMENDMENT 1: Additional requirements for integrated circuit cards
with contacts**

Cartes d'identification — Caractéristiques physiques [ISO/IEC 7810:2019/FDAmD 1](#)

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This document was prepared by Joint Technical Committee ISO/IEC JTC 1, *Information technology*, Subcommittee SC 17, *Cards and security devices for personal identification*.

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